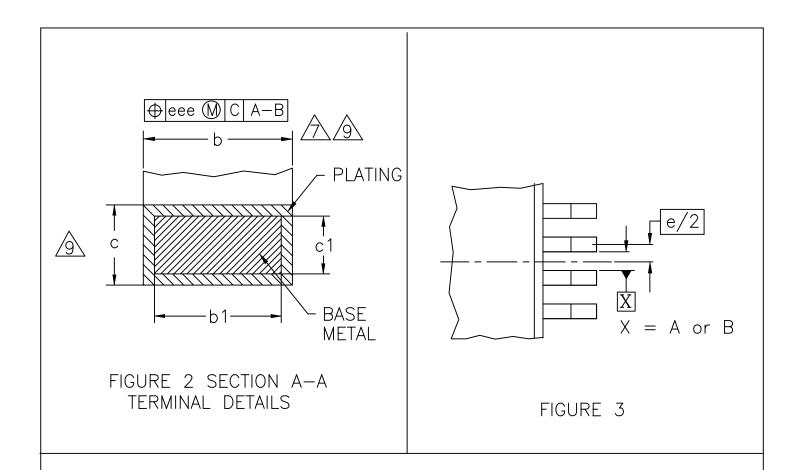


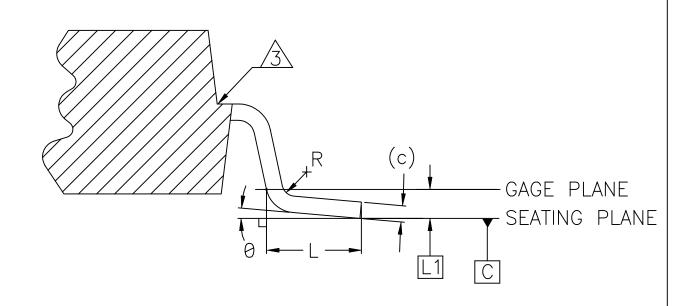
FIGURE 1
PRINCIPAL DIMENSIONS & DATUMS

JEDEC
SOLID STATE PRODUCT
OUTLINES

THIS REGISTERED OUTLINE HAS BEEN PREPARED BY THE JEDEC JC-11 COMMITTEE AND REFLECTS A PRODUCT WITH ANTICIPATED WIDE USAGE IN THE ELECTRONICS INDUSTRY; CHANGES ARE LIKELY TO OCCUR.

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FIGURE 4 SECTION B-B

SYMBOL	COMN	NOTES					
	MIN	MIN NOM MAX					
А	_	_					
A1	0.05	_	0.15				
A2	0.95	1.00	1.05				
р	0.17	0.22	0.27	7, 9			
b1	0.17	0.20	0.23	9			
С	0.10	_	0.21	9			
c1	0.10	_	9				
е		0.50 BASIC					
L	0.50	0.60					
L1		0.25 BASIC					
R	0.08	- 0.35					
θ	0	5°	8°				
GEOMETRIC TOLERANCES							
aaa		0.25					
bbb		0.10	5				
ccc		0.10	5				
ddd		0.10					
eee							
NOTES	1,2						
ISSUE		С					
REF		11-516/1-583E					

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VARIATIONS (ALL DIMENSIONS IN mm)

										$\overline{}$
SYMBOL	AA	AB	AC	AD		ВА	BB	ВС	BD	NOTES
\ <u>`</u>	BASIC	BASIC	BASIC	BASIC		BASIC	BASIC	BASIC	BASIC]위
D	14.00	16.00	18.00	20.00		14.00	16.00	18.00	20.00	4
D1	12.40	14.40	16.40	18.40		12.40	14.40	16.40	18.40	5
E	6.00	6.00	6.00	6.00		8.00	8.00	8.00	8.00	5
N	24	24	24	24		32	32	32	32	
SYMBOL	CA	СВ	СС	CD		DA	DB	DC	DD	NOTES
\X	BASIC	BASIC	BASIC	BASIC		BASIC	BASIC	BASIC	BASIC]위
D	14.00	16.00	18.00	20.00		14.00	16.00	18.00	20.00	4
D1	12.40	14.40	16.40	18.40		12.40	14.40	16.40	18.40	5
E	10.00	10.00	10.00	10.00		12.00	12.00	12.00	12.00	5
N	40	40	40	40		48	48	48	48	
NO	NOTES 1,2									
IS:	SUE				Α					
RE	EF				11-305					
SYMBOL	EA	EB	EC							NOTES
λS	BASIC	BASIC	BASIC							2
D	16.00	18.00	20.00							4
D1	14.40	16.40	18.40							5
Ε	14.00	14.00	14.00							5
N	56	56	56							
NC	DTES				1,2					
ISS	SUE				В					
RE	F				11-362					

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NOTES:

- 1. ALL DIMENSIONING AND TOLERANCING CONFORMS TO ASME Y14.5M-1994.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



 $\stackrel{\frown}{4}$ to be determined at seating plane c.

PROFILE TOLERANCE ZONES FOR D1 AND E DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTRUSION ON E IS 0.15 mm PER SIDE AND ON D1 IS 0.25 mm PER SIDE.

PIN 1 IDENTIFIER MUST BE CONTAINED WITHIN THE ZONE INDICATED. MAX. WIDTH = 1.5 mm; MAX LENGTH = 1.5 mm. DETAILS OF THE PIN 1 IDENTIFIER ARE AT USER'S OPTION.

DIMENSION 6 DOES NOT INCLUDE DAMBAR PROTRUSION.
ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 mm TOTAL IN EXCESS OF THE 6 DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD TO BE 0.07 mm.

8 EXACT SHAPE OF EACH CORNER IS OPTIONAL.

THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 mm AND 0.25 mm FROM THE LEAD TIP.

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